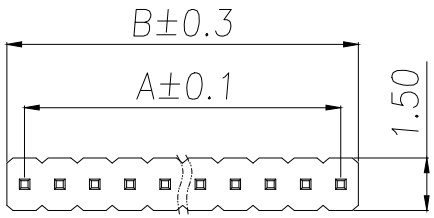
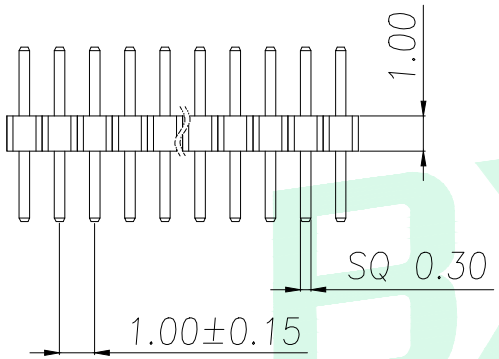
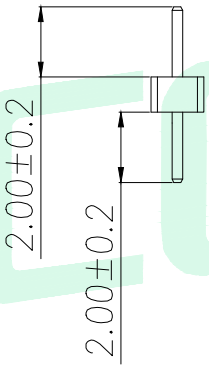
REV.	DESCRIPTION	ECN NO.	NAME	DATE

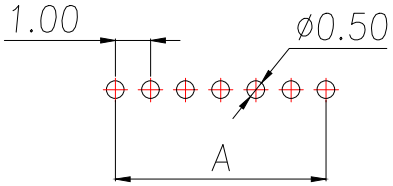


SPECIFICATIONS
Current Rating:0.75 Amps
Withstanding Voltage:AC 500V
Insulation Resistance:1000MΩ Min
Contact Resistance:20mΩ Max
Operation Temperature:−40°to+105°
Insrlator Material:Polyester(UL94V−0)
Contact Material:Phosphor bronze
Standard:PA6T
Contact Plating:Gold Flash
Max.Processing Temp:240°C for30−60seconds
(260°C for5seconds)





P/N	PIN	DIM.A	DIM.B
AZ−PZ1.0−V11−1*1P	1	0.00	1.00
AZ−PZ1.0−V11−1*2P	2	1.00	2.00
AZ−PZ1.0−V11−1*3P	3	2.00	3.00
AZ−PZ1.0−V11−1*4P	4	3.00	4.00
AZ−PZ1.0−V11−1*5P	5	4.00	5.00
AZ−PZ1.0−V11−1*6P	6	5.00	6.00
AZ−PZ1.0−V11−1*7P	7	6.00	7.00
AZ−PZ1.0−V11−1*8P	8	7.00	8.00
AZ−PZ1.0−V11−1*9P	9	8.00	9.00
.....	.....	.....	.....
AZ−PZ1.0−V11−1*50P	50	(PIN−1)	(PIN)



RECOMMEND P.C.B LAYOUT
PCB TOLERANCE:±0.05 (TOP VIEW)

GENERAL TOLERANCE						
DIM. TOL. x. ±0.30 x.x ±0.20 x.xx ±0.10 GENERAL ANGLE: x.° ±5° x.x° ±1° x.xx° ±0.5°	DONGGUAN BAOXUN PRECISION TECHNOLOGY CO., LTD					BXCONN®
	TITLE: 1.0PH H1.0 1xnPin 180度 W1.5 PC2.0 PA2.0 PB1.0 L5.0 6T					
	DWG. NO.: AZ−PZ1.0−V11−1*NP				CHECKED: MAX	
	PART NO.: AZ−PZ1.0−V11−1*NP				DRAWN: ELLA	
	UNIT: mm	SCALE: none	SHEET: 1of 1	DWG. SIZE: A4	LAYER: bxconn	APPROVED: WILL